

<b>PATENT ASSIGNMENT COVER SHEET</b>
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Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT7035352

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
TECHFLUX, INC.	11/04/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SAMSUNG ELECTRONICS CO., LTD.
<b>Street Address:</b>	129, SAMSUNG-RO, YEONGTONG-GU
<b>Internal Address:</b>	GYEONGGI-DO
<b>City:</b>	SUWON-SI
<b>State/Country:</b>	KOREA, REPUBLIC OF
<b>Postal Code:</b>	16677
<b>PROPERTY NUMBERS Total: 18</b>	
<b>Property Type</b>	<b>Number</b>
Patent Number:	9685999
Patent Number:	10355755
Patent Number:	9877324
Patent Number:	10356781
Patent Number:	9730226
Patent Number:	10660096
Patent Number:	9712297
Patent Number:	10355837
Patent Number:	9794829
Patent Number:	10674397
Patent Number:	11071014
Application Number:	17357939
Patent Number:	9730247
Patent Number:	10412763
Patent Number:	11109408
Patent Number:	10420030
Patent Number:	10986577
Patent Number:	10651977

**CORRESPONDENCE DATA****Fax Number:**

*Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.*

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<b>ATTORNEY DOCKET NUMBER:</b>	AS21-002US1
<b>NAME OF SUBMITTER:</b>	JEONGHWAN PARK
<b>SIGNATURE:</b>	/Jeonghwan Park/
<b>DATE SIGNED:</b>	11/19/2021

**Total Attachments: 2**

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source=ASSIGNMENT\_TechFlus\_Samsung\_20211104#page2.tif

EXHIBIT B

ASSIGNMENT OF PATENT RIGHTS (US)


TechFlux, Inc., a corporation with its principal place of business at 30-9 Walhyunwii Road, Jankun-myeon, Seojong-si, 30055, the Republic of Korea ("Assignor") declares that it is the sole owner of the patents and patent applications set forth on Attachment 1 hereto.

For valuable consideration, the receipt and adequacy of which is hereby acknowledged, Assignor hereby sells, assigns, and transfers unto Samsung Electronics Co., Ltd a corporation incorporated under the laws of the Republic of KOREA (the "Assignee"), the sole and entire right, title, and interest that exist today and may exist in the future in and to the patents and patent applications set forth on Attachment 1 hereto, including all rights pursuant to 35 U.S.C. § 154 and any and all Letters Patent issuing therefrom, and any and all reissues, reexaminations, extensions, continuations, continuations-in-part, divisionals, provisionals, substitutions, renewals, and registrations of any item in the foregoing; all inventions and discoveries described in any of the foregoing; and any and all patents, patent applications and counterparts arising from any item in the foregoing (the "Assigned Patents"); and all past, present, and future causes of action and claims for damages derived by reason of patent infringement thereof, for said Assignee's own use and for the use of its assigns, successors, and legal representatives to the full end of the term of each of the Assigned Patents.

Assignor hereby authorizes the respective patent office or governmental agency in each jurisdiction to issue any and all patents, certificates of invention, utility models or other governmental grants or issuances that may be granted upon any of the Assigned Patents in the name of Assignee, as the assignee to the entire interest therein.

IN WITNESS WHEREOF this Assignment is executed on Nov. 4th, 2021.

Assignor: TechFlux, Inc.

Signature 

DAEHEE LEE  
Printed Name

CEO  
Title

Nov. 4th, 2021  
Date

HC



**Attachment 1 to Assignment of Patent Rights (US)**  
**List of Assigned Patents**

Country	Patent No. / Publication No.
US	US9685999
US	US10355755
US	US9877324
US	US10356781
US	US9730226
US	US10660096
US	US9712297
US	US10355837
US	US9794829
US	US10674397
US	US11071014
US	17/357,939
US	US9730247
US	US10412763
US	US11109408
US	US10420030
US	US10986577
US	US10651977

*Handwritten initials/signature*